

FORM PTO-1449 <i>O P E JCS</i>	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. <b>108077-00000</b>	SERIAL NO. <b>09/648,750</b>
<b>LIST OF REFERENCES CITED BY APPLICANT</b> (Use several sheets if necessary)		APPLICANT <b>UCHIBORI</b>	
		FILING DATE <b>August 28, 2000</b>	GROUP <b>2825</b>

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION YES NO
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						

**OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)**

<i>G</i>	AM	Kwak, et al. "Improvement of Ta Diffusion barrier performance in Cu Metallization by Insertion of a thin Zr Layer into Ta Film" Appl. Phys., Lett. Vol. 72, pp. 2832-2834
<i>L</i>	AN	
<i>L</i>	AO	

EXAMINER <i>Jawith</i>	DATE CONSIDERED <i>7/1/04</i>
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

## PRIOR ART INFORMATION LIST

U.S. Patent Application No. 09/815,010  
Your ref: P3374-698-A-010393  
Our ref: 2000-325802

No.	Inventor, Patent Number, County, Author, Title, Name of Document	Issue Date	Concise Explanation of the Relevance (indication of page, column, line, figure of the relevant portion)
1.	U.S.P. 5,595,937	Jan. 21, 1997	FIG. 5H

*[Handwritten signature]* 2/1/09